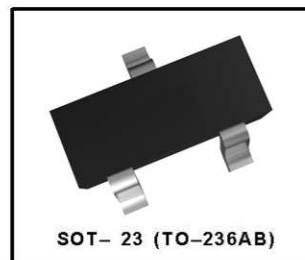
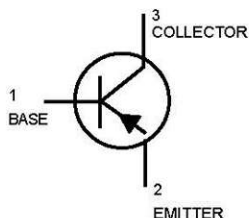


PNP Silicon



● MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CE0}	– 150	Vdc
Collector–Base Voltage	V_{CBO}	– 160	Vdc
Emitter–Base Voltage	V_{EBO}	– 5.0	Vdc
Collector Current — Continuous	I_C	– 500	mAdc

● THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR- 5 Board (1) $T_A=25\text{ }^\circ\text{C}$ Derate above $25\text{ }^\circ\text{C}$	P_D	225 1.8	mW mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (2) $T_A = 25\text{ }^\circ\text{C}$ Derate above $25\text{ }^\circ\text{C}$	P_D	300 2.4	mW mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T_J, T_{stg}	–55to+150	°C

● DEVICE MARKING

MMBT5401LT1=2L

● ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage ($I_C = -1.0\text{ mAdc}, I_B = 0$)	$V_{(BR)CEO}$	– 150	—	Vdc
Collector–Base Breakdown Voltage ($I_C = -100\text{ }\mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	– 160	—	Vdc
Emitter–Base Breakdown Voltage ($I_E = -10\text{ }\mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	– 5.0	—	Vdc
Collector Cutoff Current ($V_{CB} = -120\text{ Vdc}, I_E = 0$)	I_{CES}	—	– 50	nAdc
($V_{CB} = -120\text{ Vdc}, I_E = 0, T_A = 100\text{ }^\circ\text{C}$)		—	– 50	μAdc

1. FR-5 = 1.0 x 0.75 x 0.062 in.

2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.



● **ELECTRICAL CHARACTERISTICS** ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS (2)				
DC Current Gain ($I_C = -1.0\text{mA dc}$, $V_{CE} = -5.0\text{V dc}$)	h_{FE}	50	—	—
($I_C = -10\text{mA dc}$, $V_{CE} = -5.0\text{V dc}$)		60	240	
($I_C = -50\text{mA dc}$, $V_{CE} = -5.0\text{V dc}$)		50	—	
Collector–Emitter Saturation Voltage ($I_C = -10\text{mA dc}$, $I_B = -1.0\text{mA dc}$)	$V_{CE(sat)}$	—	- 0.2	V dc
($I_C = -50\text{mA dc}$, $I_B = -5.0\text{mA dc}$)		—	- 0.5	
Base–Emitter Saturation Voltage ($I_C = -10\text{mA dc}$, $I_B = -1.0\text{mA dc}$)	$V_{BE(sat)}$	—	- 1.0	V dc
($I_C = -50\text{mA dc}$, $I_B = -5.0\text{mA dc}$)		—	- 1.0	

● **SMALL–SIGNAL CHARACTERISTICS**

Current–Gain — Bandwidth Product ($I_C = -10\text{mA dc}$, $V_{CE} = -10\text{V dc}$, $f = 100\text{MHz}$)	f_T	100	300	MHz
Output Capacitance ($V_{CB} = -10\text{V dc}$, $I_E = 0$, $f = 1.0\text{MHz}$)	C_{obo}	—	6.0	pF
Small–Signal Current Gain ($I_C = -1.0\text{mA dc}$, $V_{CE} = -10\text{V dc}$, $f = 1.0\text{kHz}$)	h_{fe}	40	200	—
Noise Figure ($I_C = -200\text{μA dc}$, $V_{CE} = -5.0\text{V dc}$, $R_s = 10\Omega$, $f = 1.0\text{kHz}$)	NF	—	8.0	dB



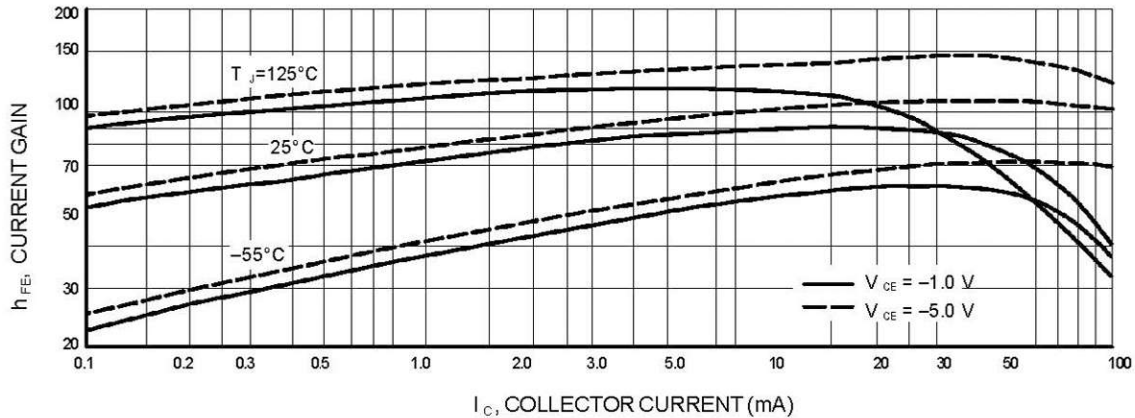


Figure 1. DC Current Gain

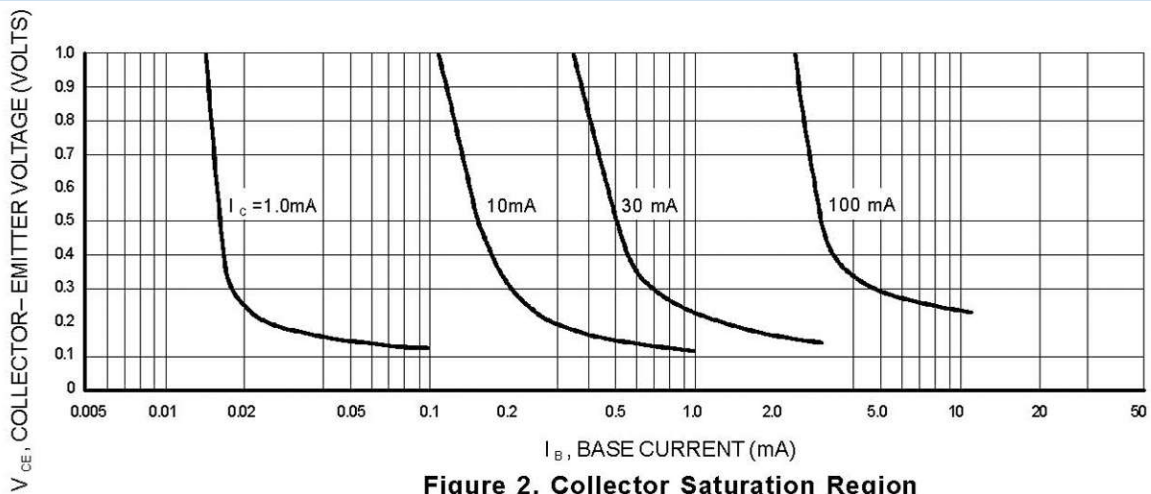


Figure 2. Collector Saturation Region

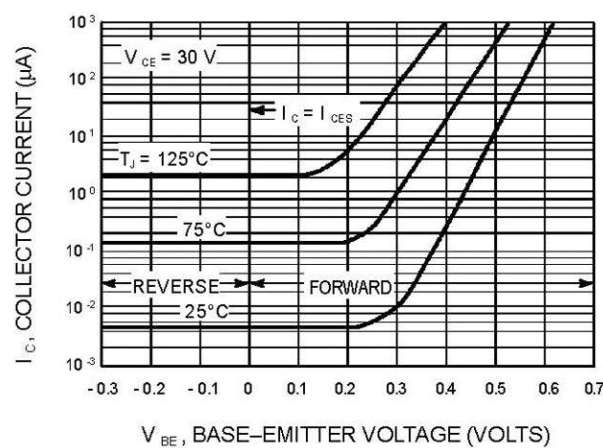


Figure 3. Collector Cut-Off Region



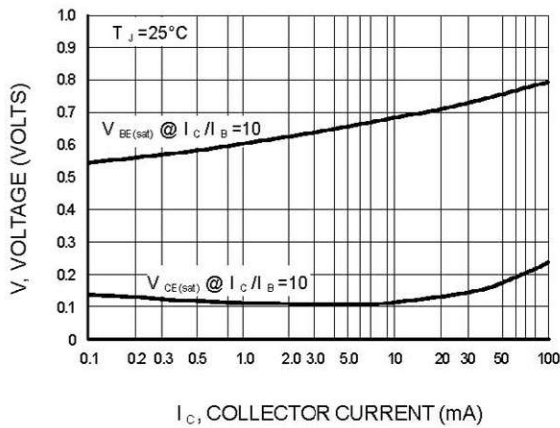


Figure 4. "On" Voltages

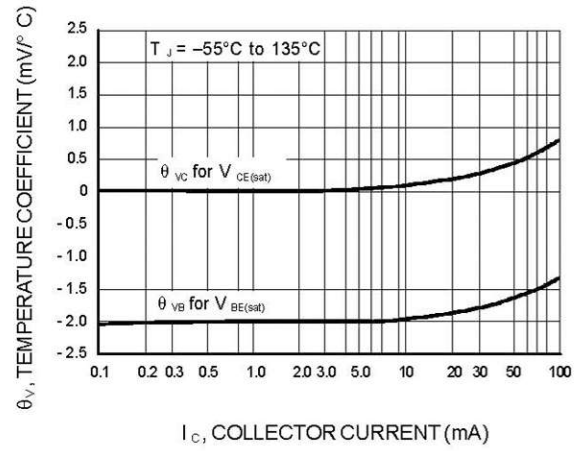


Figure 5. Temperature Coefficients

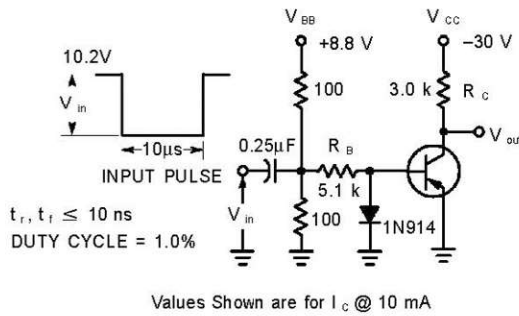


Figure 6. Switching Time Test Circuit

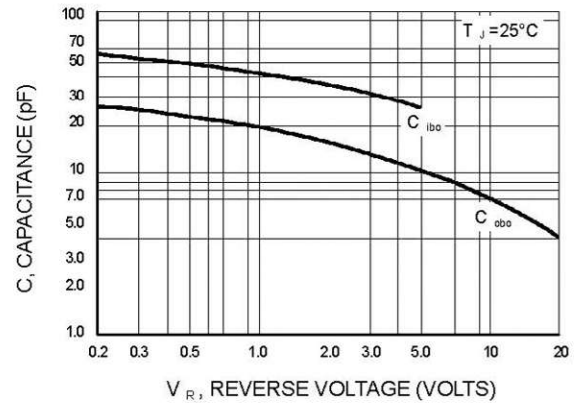


Figure 7. Capacitances

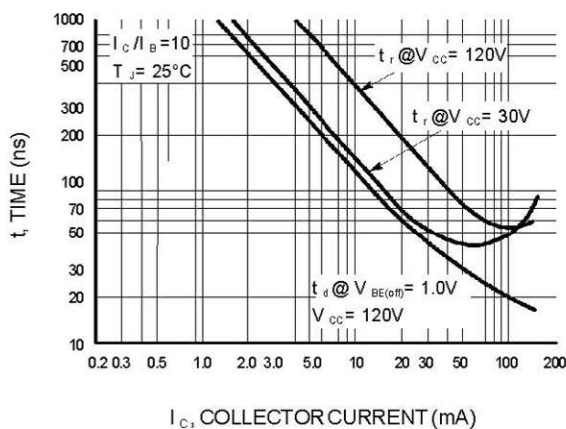


Figure 8. Turn-On Time

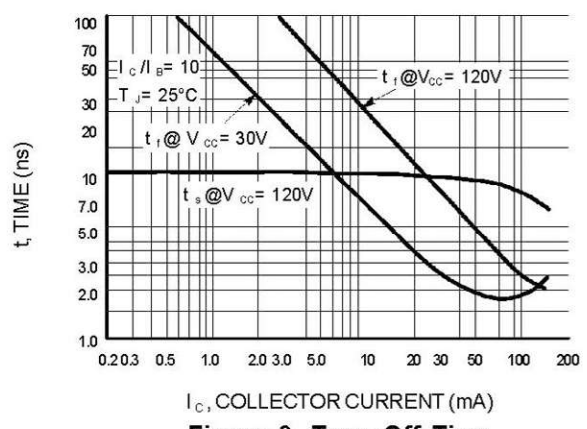


Figure 9. Turn-Off Time

